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FDMD8240L

Dual N-Channel Power Trench® MOSFET 40 V, 98 A, 2.6 mΩ

Features

- Max $r_{DS(on)}$ = 2.6 mΩ at $V_{GS} = 10$ V, $I_D = 23$ A
- Max $r_{DS(on)}$ = 3.95 mΩ at $V_{GS} = 4.5$ V, $I_D = 19$ A
- Ideal for Flexible Layout in Primary Side of Bridge Topology
- 100% UIL Tested
- Kelvin High Side MOSFET Drive Pin-out Capability
- Termination is Lead-free and RoHS Compliant

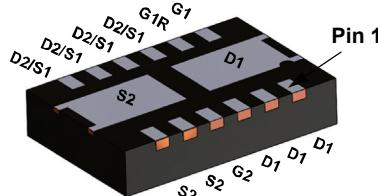
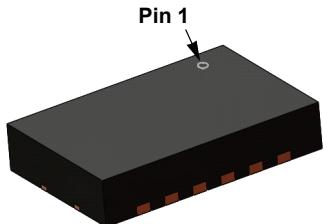


General Description

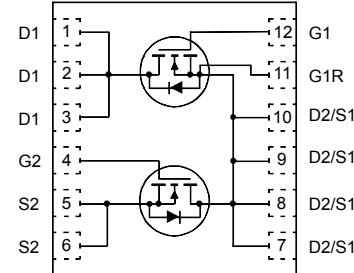
This device includes two 40V N-Channel MOSFETs in a dual Power (3.3 mm X 5 mm) package. HS source and LS Drain are internally connected for half/full bridge, low source inductance package, low $r_{DS(on)}/Qg$ FOM silicon.

Applications

- Synchronous Buck : Primary Switch of Half / Full Bridge Converter for Telecom
- Motor Bridge : Primary Switch of Half / Full bridge Converter for BLDC Motor
- MV POL: Synchronous Buck Switch



Power 3.3 x 5



MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Ratings	Units
V_{DS}	Drain to Source Voltage	40	V
V_{GS}	Gate to Source Voltage	± 20	V
I_D	Drain Current -Continuous $T_C = 25$ °C (Note 5)	98	A
	-Continuous $T_C = 100$ °C (Note 5)	62	
	-Continuous $T_A = 25$ °C (Note 1a)	23	
	-Pulsed (Note 4)	464	
E_{AS}	Single Pulse Avalanche Energy (Note 3)	216	mJ
P_D	Power Dissipation $T_C = 25$ °C	42	W
	Power Dissipation $T_A = 25$ °C (Note 1a)	2.1	
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.0	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	60	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
8240L	FDMD8240L	Power 3.3 x 5	13 "	12 mm	3000 units

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0 \text{ V}$	40			V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, referenced to 25°C		23		$\text{mV/}^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32 \text{ V}, V_{GS} = 0 \text{ V}$		1	μA	
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			± 100	nA

On Characteristics

$V_{GS(\text{th})}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$	1.0	2.0	3.0	V
$\frac{\Delta V_{GS(\text{th})}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, referenced to 25°C		-6		$\text{mV/}^\circ\text{C}$
$r_{DS(\text{on})}$	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 23 \text{ A}$		2.0	2.6	$\text{m}\Omega$
		$V_{GS} = 4.5 \text{ V}, I_D = 19 \text{ A}$		3.2	3.95	
		$V_{GS} = 10 \text{ V}, I_D = 23 \text{ A}, T_J = 125^\circ\text{C}$		3.0	3.9	
g_{FS}	Forward Transconductance	$V_{DD} = 5 \text{ V}, I_D = 23 \text{ A}$		107		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$ $f = 1 \text{ MHz}$		3020	4230	pF
C_{oss}	Output Capacitance			876	1230	pF
C_{rss}	Reverse Transfer Capacitance			33	52	pF
R_g	Gate Resistance		0.1	2.8	6	Ω

Switching Characteristics

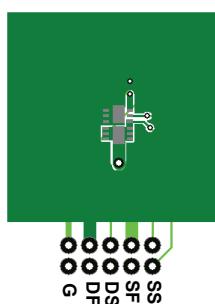
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{DD} = 20 \text{ V}, I_D = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, R_{\text{GEN}} = 6 \Omega$		12	22	ns
t_r	Rise Time			8	16	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time			36	58	ns
t_f	Fall Time			9	18	ns
$Q_{\text{g(TOT)}}$	Total Gate Charge	$V_{GS} = 0 \text{ V} \text{ to } 10 \text{ V}$		40	56	nC
	Total Gate Charge	$V_{GS} = 0 \text{ V} \text{ to } 5 \text{ V}$	$V_{DD} = 20 \text{ V}$ $I_D = 23 \text{ A}$	21	30	nC
Q_{gs}	Gate to Source Charge			9		nC
Q_{gd}	Gate to Drain "Miller" Charge			5		nC

Drain-Source Diode Characteristics

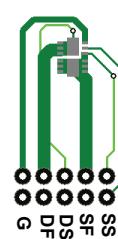
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 23 \text{ A}$ (Note 2)		0.8	1.3	V
		$V_{GS} = 0 \text{ V}, I_S = 1.6 \text{ A}$ (Note 2)		0.7	1.2	
t_{rr}	Reverse Recovery Time	$I_F = 23 \text{ A}, \text{di/dt} = 100 \text{ A}/\mu\text{s}$		41	65	ns
				21	32	nC

NOTES:

1. R_{QJA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{QJC} is guaranteed by design while R_{QCA} is determined by the user's board design.



a. 60 °C/W when mounted on a 1 in² pad of 2 oz copper



b. 130 °C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300 μs , Duty cycle < 2.0 %.

3. E_{AS} of 216 mJ is based on starting $T_J = 25^\circ\text{C}$, $L = 3 \text{ mH}$, $I_{\text{AS}} = 12 \text{ A}$, $V_{DD} = 40 \text{ V}$, $V_{GS} = 10 \text{ V}$. 100% tested at $L = 0.1 \text{ mH}$, $I_{\text{AS}} = 37 \text{ A}$.

4. Pulsed I_d please refer to Fig 11 SOA graph for more details.

5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted.

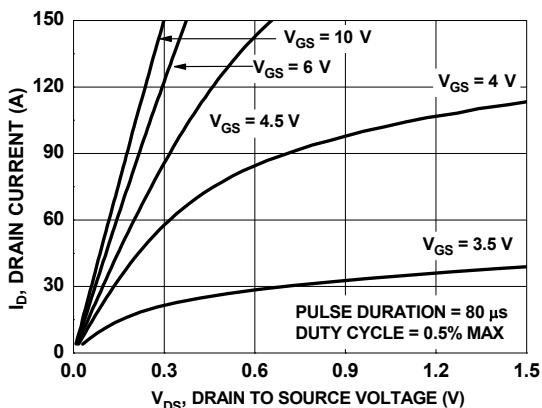


Figure 1. On-Region Characteristics

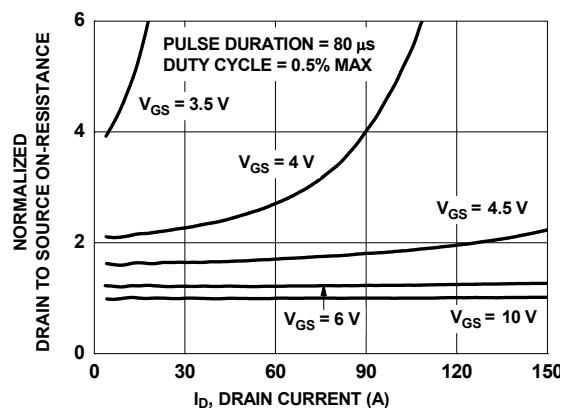


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

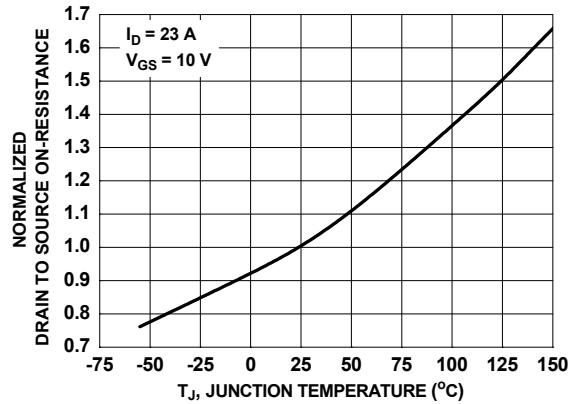


Figure 3. Normalized On Resistance vs. Junction Temperature

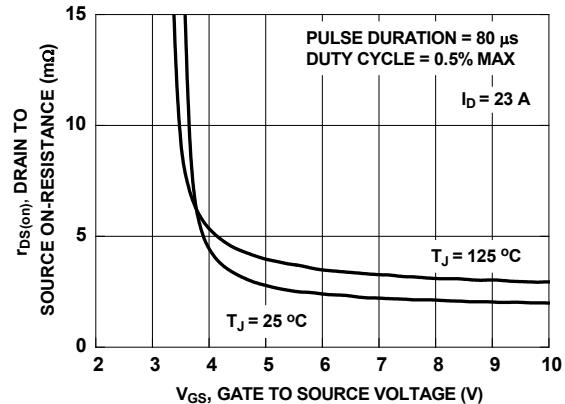


Figure 4. On Resistance vs. Gate to Source Voltage

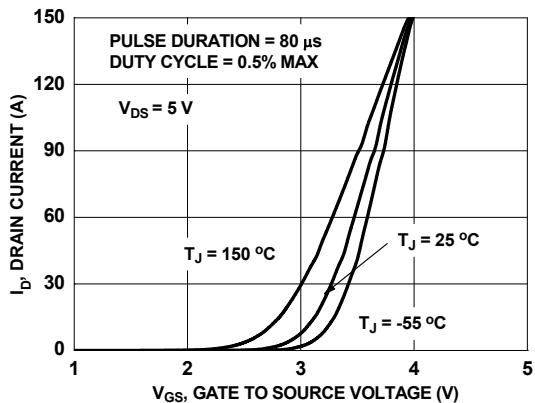


Figure 5. Transfer Characteristics

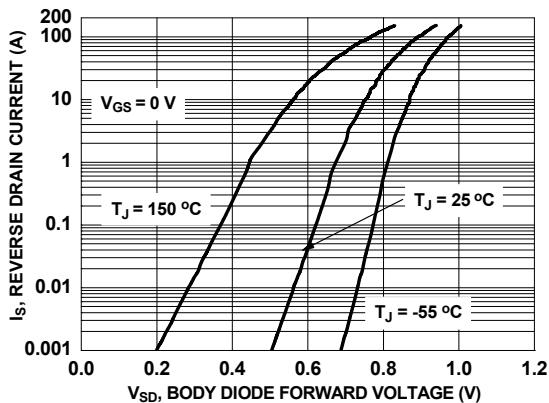


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

Typical Characteristics $T_J = 25$ °C unless otherwise noted.

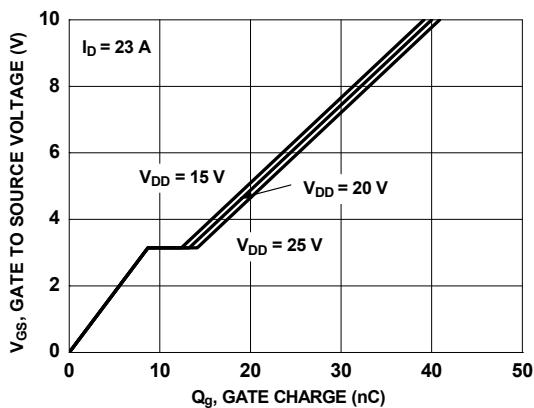


Figure 7. Gate Charge Characteristics

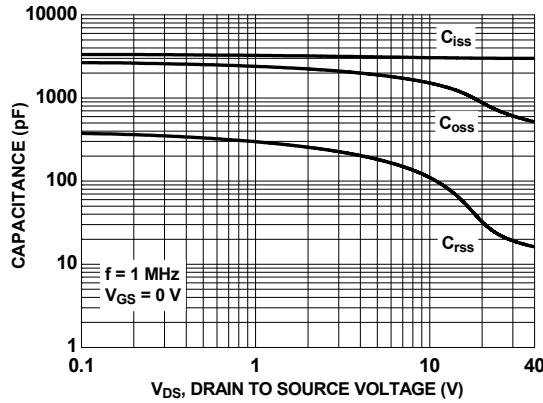


Figure 8. Capacitance vs. Drain to Source Voltage

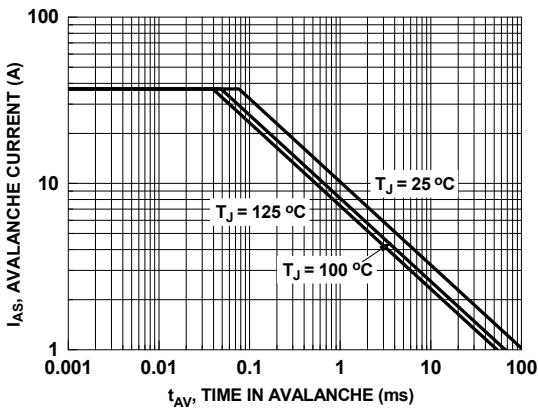


Figure 9. Unclamped Inductive Switching Capability

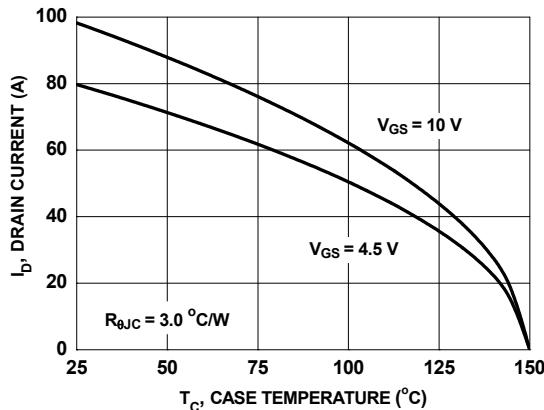


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

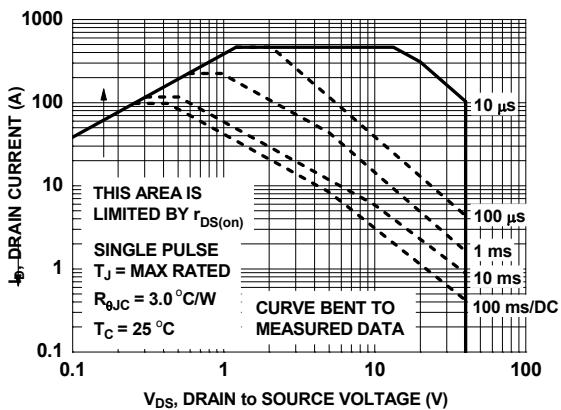


Figure 11. Forward Bias Safe Operating Area

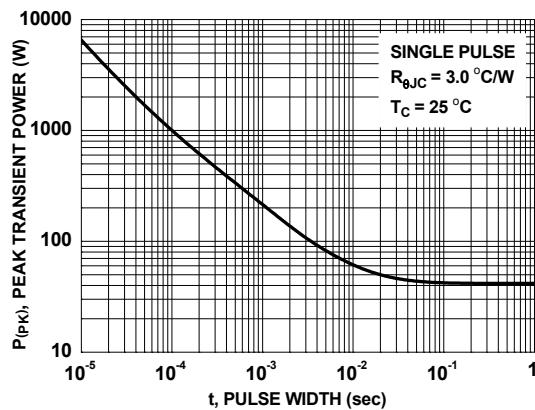


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted.

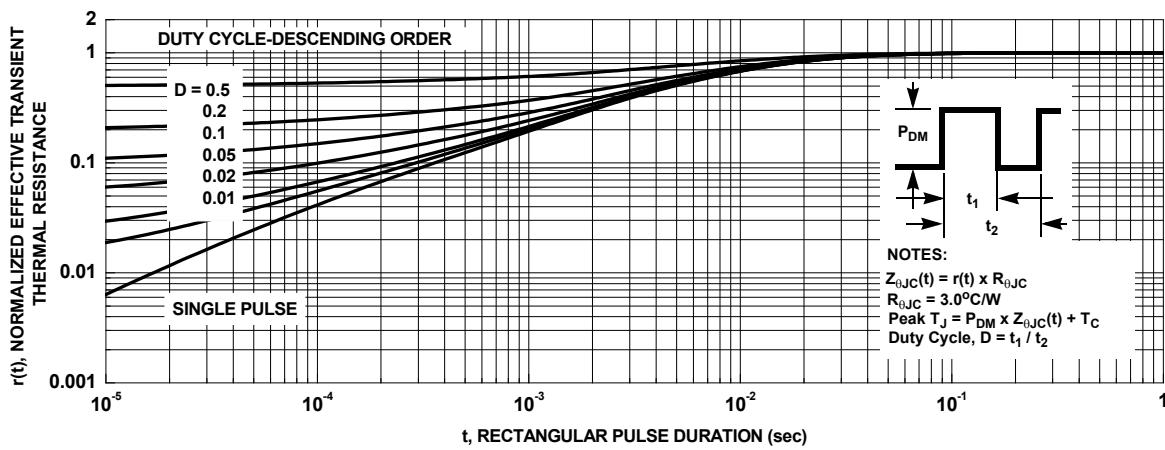
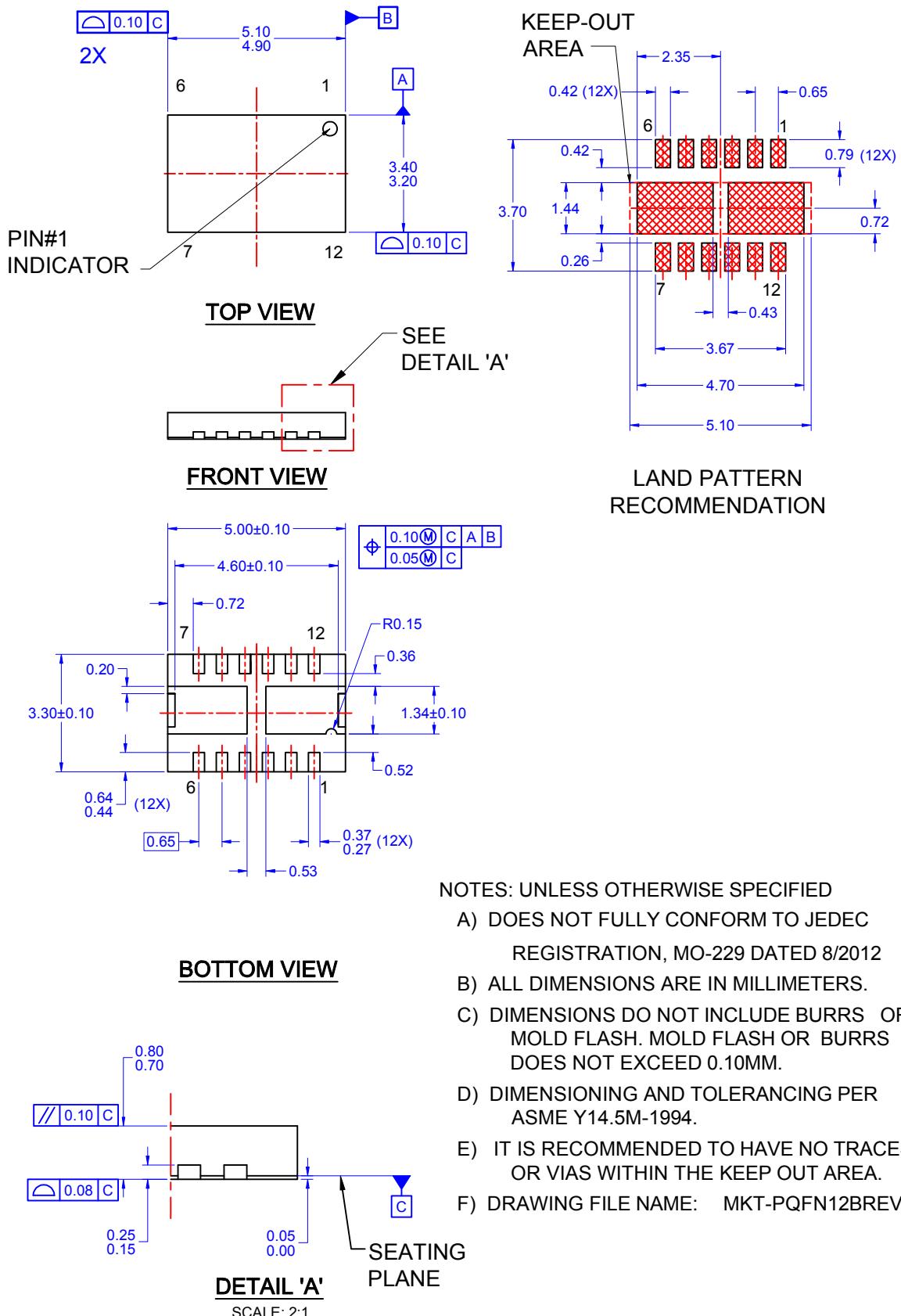


Figure 13. Junction-to-Case Transient Thermal Response Curve



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